



SGA1J

Surface Mount Glass Passivated Standard Rectifier  
Reverse Voltage 600V Forward Current 1A

## Features

- Glass passivated Standard Rectifiers
- Very low profile - typical height of 1.0 mm
- Low forward voltage drop , Low leakage current
- ESD capability
- Moisture sensitivity: level 1, per J-STD-020
- AEC-Q101 qualified
- High temperature soldering guaranteed: 260 /10 seconds
- Halogen-free according to IEC 61249-2-21 definition

eSGA  
(SOD-123FL)

## TYPICAL APPLICATIONS

For use of general purpose rectification,power supplies and other consumer applications,polarity protection, and reverse polarity protection in both consumer and automotive applications.

MAXIMUM RATINGS (TA = 25 °C unless otherwise noted)			
PARAMETER	SYMBOL	SGA1J	UNIT
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	600	V
Maximum RMS voltage	V <sub>RMS</sub>	420	V
Maximum DC blocking voltage	V <sub>DC</sub>	600	V
Maximum average forward rectified current	I <sub>F(AV)</sub>	1.0	A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	25	A
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>TSG</sub>	- 55 to + 150	°C

ELECTRICAL CHARACTERISTICS (TA = 25 °C unless otherwise noted)				
PARAMETER	TEST CONDITIONS	SYMBOL	SGA1J	UNIT
Maximum instantaneous forward voltage	1 A	V <sub>F</sub>	1.0	Volts
Maximum DC reverse current at rated DC blocking voltage	TA=25 TA=125	I <sub>R</sub>	5 50	µA
Typical reverse recovery time	I <sub>F</sub> =0.5A, I <sub>R</sub> =1.0A, I <sub>rr</sub> =0.25A	t <sub>rr</sub>	1.8	µs
Typical junction capacitance	4.0 V, 1 MHz	C <sub>J</sub>	6	pF



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#### IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS

(TA=25°C, unless otherwise noted)

STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
JESD22-A114/AEC-Q101-001	Human body model(contact mode)	C=100pF,R=1.5KΩ	VC	H3A	> 4KV
JESD22-A115/AEC-Q101-002	Machine model(contact mode)	C=200pF,R=0Ω		M4	> 400V

#### THERMAL CHARACTERISTICS(TA=25°C,unless otherwise noted)

PARAMETER	SYMBOL	SGA1J	UNIT
Typical thermal resistance	R <sub>θJA</sub>	70	/W
	R <sub>θJM</sub>	15	
	R <sub>θJC</sub>	35	

Note: Thermal resistance from junction to ambient and junction to lead mounted on PCB with 5.0mm\*5.0mm copper pad areas.

#### RATINGS AND CHARACTERISTICS CURVES

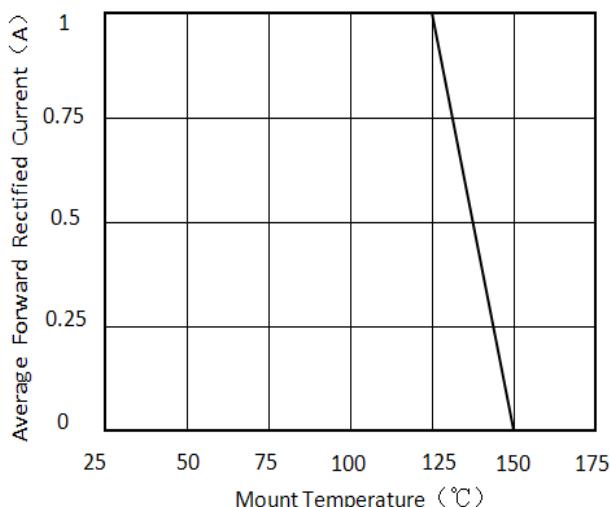


Figure 1. Forward Current Derating Curve

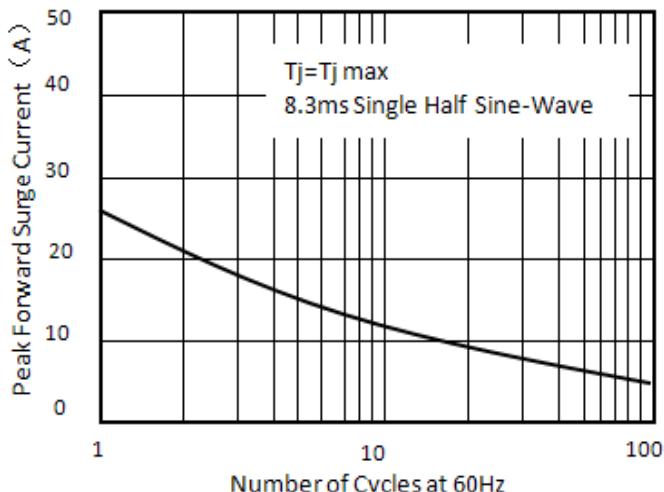


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

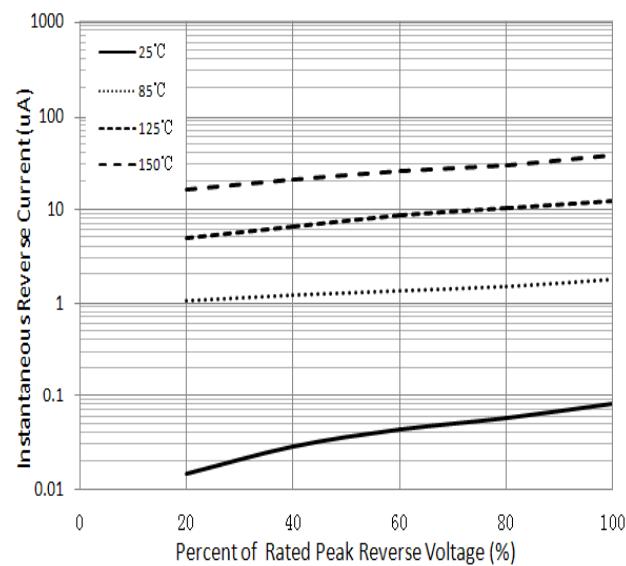


Figure 3. Typical Reverse Characteristics

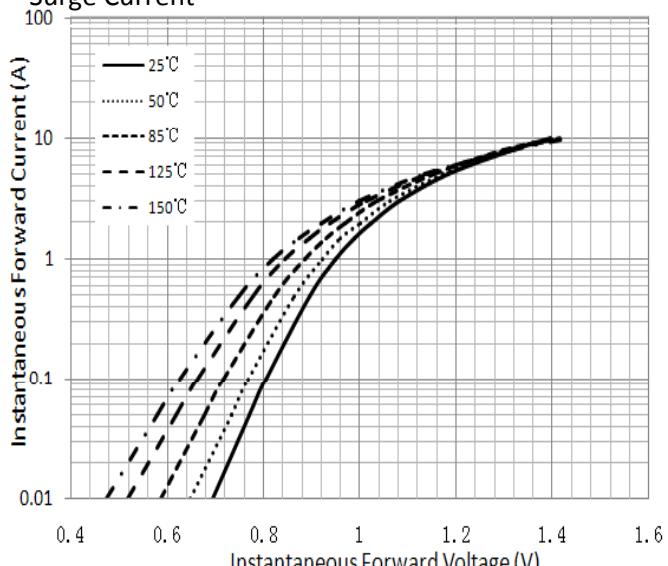
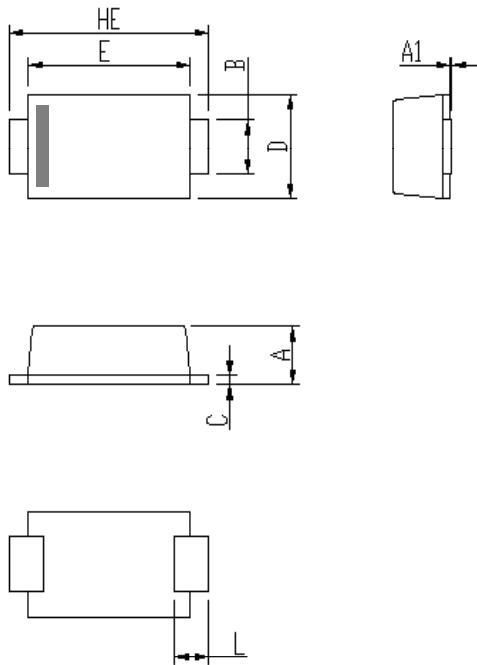


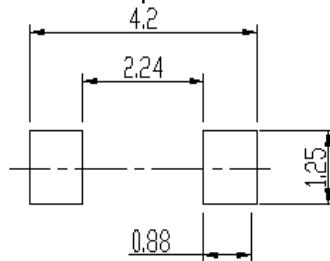
Figure 4. Typical Forward Characteristics

## PACKAGE OUTLINE DIMENSIONS



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
A	0.9	1.08	0.035	0.043
A1	0	0.1	0.000	0.004
B	0.85	1.05	0.033	0.041
C	0.1	0.25	0.004	0.010
D	1.7	2	0.067	0.079
E	2.9	3.1	0.114	0.122
L	0.43	0.83	0.017	0.033
HE	3.5	3.9	0.138	0.154

Soldering  
footprint



## PACKING INFORMATION

### Packing quantities:

3000 pcs/Reel, 40 Reels/Box; 8mm Tape, 7" Reel

### Tape & Reel Specification

